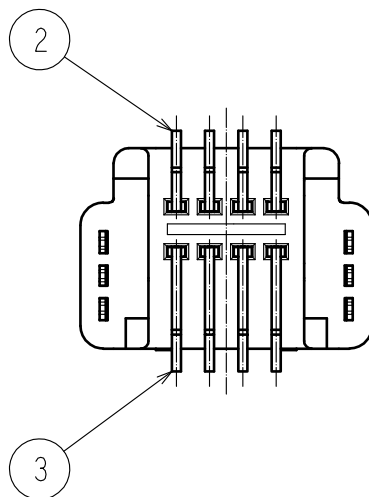
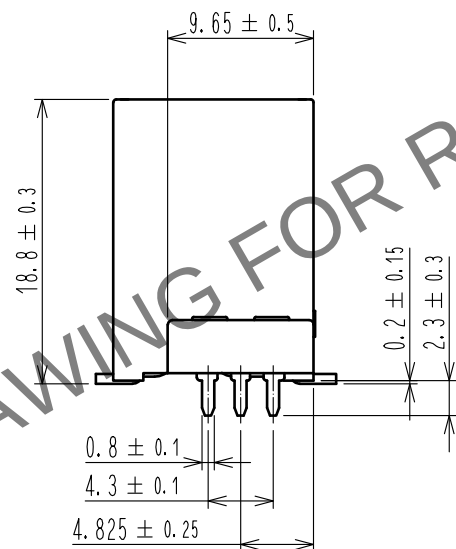
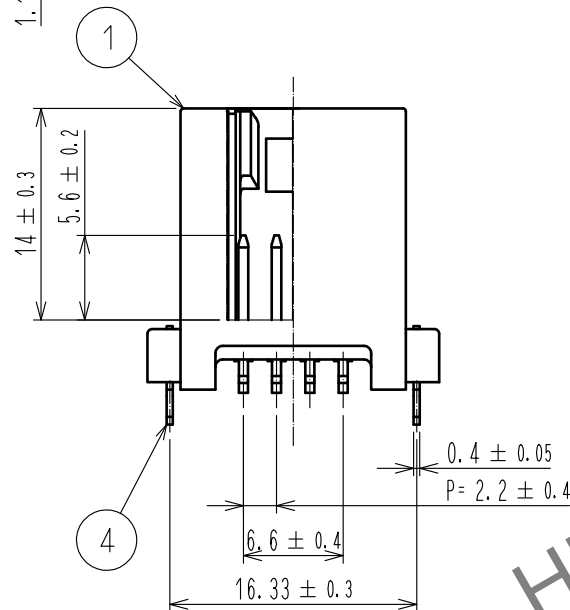
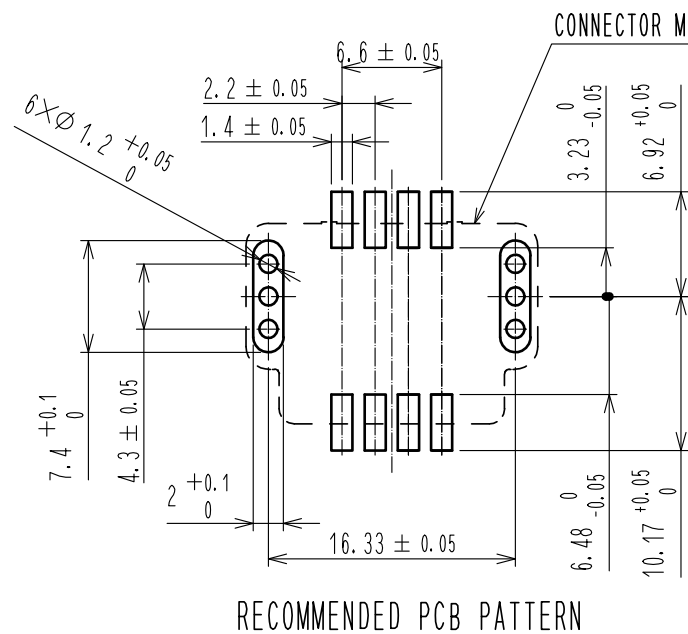
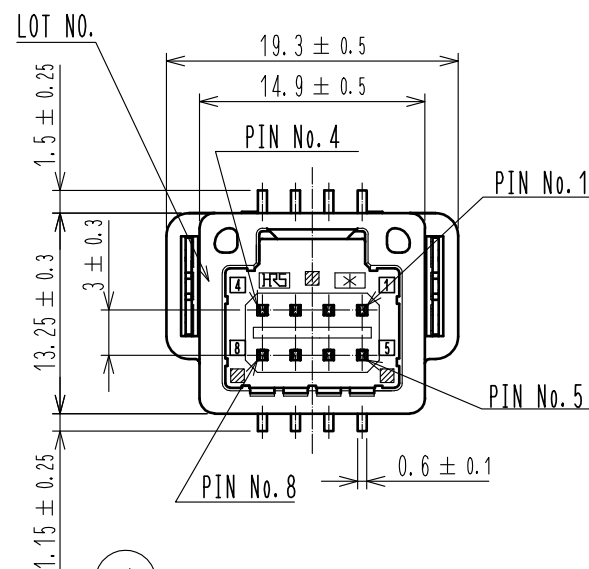
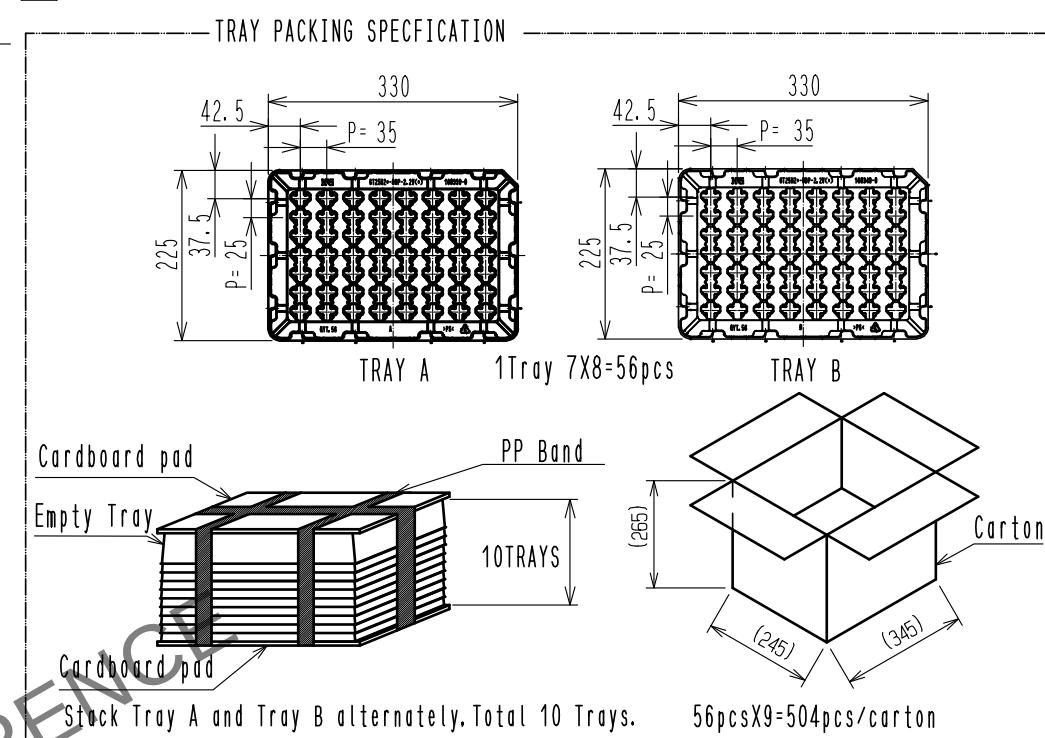


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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

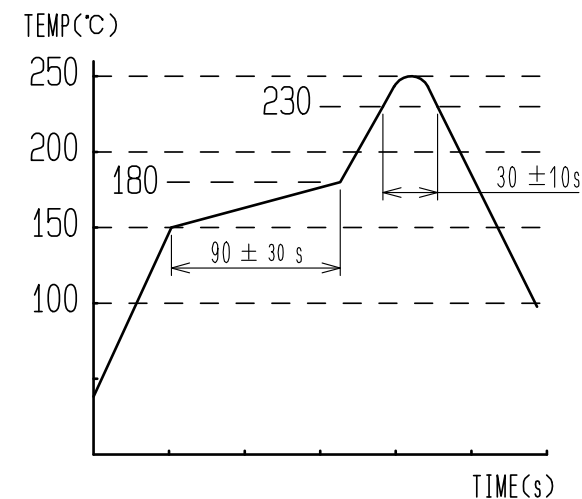
ELV, RoHS COMPLIANT



Additional of [TRAY PACKING SPECIFICATION]



- NOTE 1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW
(REFER TO RIGHT FIG.)
USED REFLOW SYSTEM : IR IN THE AIR OR NITROGEN
NO. OF CYCLES : 2 MAX
PEAK : 250°C
OVER 230°C : 20~40s
PREHEAT : 150~180°C
60~120s
2. TEMPERATURE FOR SOLDERING IRON : 280~300°C WITHIN 2s
3. CO-PLANARITY SHALL BE 0.1mm MAX.
4. RECOMMENDED PCB THICKNESS IS 1.6mm.
5. RECOMMENDED SOLDER THICKNESS IS 0.15mm.



2	BRASS	TIN PLATED T=0.64	4	BRASS	TIN PLATED T=0.4
1	PPS	BLACK	3	BRASS	TIN PLATED T=0.64
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 1	DESCRIPTION OF REVISIONS DIS-T-00019473	DESIGNED TY. IKEDA
		APPROVED : NH. NAKATA	20151028	DRAWING NO.	EDC-364861-00-00
		CHECKED : HS. OZAWA	20151028	PART NO.	GT25H2-8DP-2.2V
		DESIGNED : TK. SHISHIKURA	20151028	CODE NO.	CL0775-0094-0-00
		DRAWN : TK. SHISHIKURA	20151028		
		DATE	20231109		